

# MOSFET

## OptiMOS™ Power-Transistor, -150 V

### Features

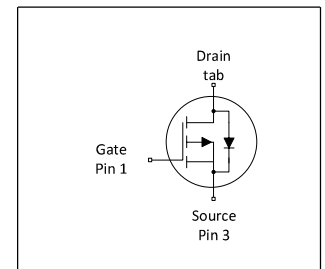
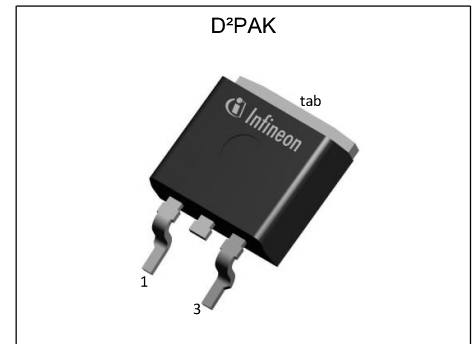
- P-channel
- Very low on-resistance  $R_{DS(on)}$  @  $V_{GS}=4.5\text{ V}$
- 100% avalanche tested
- Logic level
- Enhancement mode
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

### Product validation

Fully qualified according to JEDEC for Industrial Applications

**Table 1 Key Performance Parameters**

| Parameter        | Value | Unit       |
|------------------|-------|------------|
| $V_{DS}$         | -150  | V          |
| $R_{DS(on),max}$ | 72    | m $\Omega$ |
| $I_D$            | -41   | A          |
| $Q_{oss}$        | -61   | nC         |
| $Q_G$            | -224  | nC         |



RoHS

| Type / Ordering Code | Package    | Marking  | Related Links |
|----------------------|------------|----------|---------------|
| IPB720P15LM          | PG-TO263-3 | 720P15LM | -             |

## Table of Contents

|   |    |
|---|----|
| Description .....                         | 1  |
| Maximum ratings .....                     | 3  |
| Thermal characteristics .....             | 3  |
| Electrical characteristics .....          | 4  |
| Electrical characteristics diagrams ..... | 6  |
| Package Outlines .....                    | 10 |
| Revision History .....                    | 11 |
| Trademarks .....                          | 11 |
| Disclaimer .....                          | 11 |

## 1 Maximum ratings

at  $T_A=25\text{ °C}$ , unless otherwise specified

**Table 2 Maximum ratings**

| Parameter                                    | Symbol            | Values |      |                           | Unit | Note / Test Condition   |
|--|-------------------|--------|------|---------------------------|------|---|
|  |                   | Min.   | Typ. | Max.                      |      |   |
| Continuous drain current <sup>1)</sup>       | $I_D$             | -      | -    | -41<br>-29<br>-29<br>-4.6 | A    | $V_{GS}=-10\text{ V}$ , $T_C=25\text{ °C}$<br>$V_{GS}=-10\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=-4.5\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=-4.5\text{ V}$ , $T_A=25\text{ °C}$ , $R_{THJA}=40\text{ °C/W}^2)$ |
| Pulsed drain current <sup>3)</sup>           | $I_{D,pulse}$     | -      | -    | -164                      | A    | $T_A=25\text{ °C}$  |
| Avalanche energy, single pulse <sup>4)</sup> | $E_{AS}$          | -      | -    | 2020                      | mJ   | $I_D=-37\text{ A}$ , $R_{GS}=25\text{ }\Omega$  |
| Gate source voltage                          | $V_{GS}$          | -20    | -    | 20                        | V    | -   |
| Power dissipation                            | $P_{tot}$         | -      | -    | 300<br>3.8                | W    | $T_C=25\text{ °C}$<br>$T_A=25\text{ °C}$ , $R_{THJA}=40\text{ °C/W}^2)$   |
| Operating and storage temperature            | $T_j$ , $T_{stg}$ | -55    | -    | 175                       | °C   | IEC climatic category; DIN IEC 68-1: 55/175/56  |

## 2 Thermal characteristics

**Table 3 Thermal characteristics**

| Parameter   | Symbol     | Values |      |      | Unit | Note / Test Condition |
|---|------------|--------|------|------|------|-----------------------|
|   |            | Min.   | Typ. | Max. |      |                       |
| Thermal resistance, junction - case                                     | $R_{thJC}$ | -      | -    | 0.5  | °C/W | -                     |
| Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area  | $R_{thJA}$ | -      | -    | 40   | °C/W | -                     |
| Thermal resistance, junction - ambient, minimal footprint <sup>2)</sup> | $R_{thJA}$ | -      | -    | 62   | °C/W | -                     |

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

### 3 Electrical characteristics

at  $T_j=25\text{ °C}$ , unless otherwise specified

**Table 4 Static characteristics**

| Parameter                        | Symbol        | Values |              |            | Unit             | Note / Test Condition   |
|----------------------------------|---------------|--------|--------------|------------|------------------|---|
|                                  |               | Min.   | Typ.         | Max.       |                  |   |
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | -150   | -            | -          | V                | $V_{GS}=0\text{ V}$ , $I_D=-1\text{ mA}$  |
| Gate threshold voltage           | $V_{GS(th)}$  | -1     | -1.5         | -2         | V                | $V_{DS}=V_{GS}$ , $I_D=-5550\text{ }\mu\text{A}$  |
| Zero gate voltage drain current  | $I_{DSS}$     | -      | -0.1<br>-10  | -1<br>-100 | $\mu\text{A}$    | $V_{DS}=-150\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=25\text{ °C}$<br>$V_{DS}=-150\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=125\text{ °C}$ |
| Gate-source leakage current      | $I_{GSS}$     | -      | -10          | -100       | nA               | $V_{GS}=-20\text{ V}$ , $V_{DS}=0\text{ V}$   |
| Drain-source on-state resistance | $R_{DS(on)}$  | -      | 60.1<br>59.6 | 72<br>73   | $\text{m}\Omega$ | $V_{GS}=-10\text{ V}$ , $I_D=-37\text{ A}$<br>$V_{GS}=-4.5\text{ V}$ , $I_D=-30\text{ A}$   |
| Gate resistance                  | $R_G$         | -      | 5.3          | -          | $\Omega$         | -   |
| Transconductance                 | $g_{fs}$      | -      | 89           | -          | S                | $ V_{DS} \geq 2 I_D R_{DS(on)max}$ , $I_D=-37\text{ A}$   |

**Table 5 Dynamic characteristics**

| Parameter                                  | Symbol       | Values |        |       | Unit | Note / Test Condition  |
|--|--------------|--------|--------|-------|------|--|
|  |              | Min.   | Typ.   | Max.  |      |  |
| Input capacitance <sup>1)</sup>            | $C_{iss}$    | -      | 8400   | 11000 | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=-75\text{ V}$ , $f=1\text{ MHz}$   |
| Output capacitance <sup>1)</sup>           | $C_{oss}$    | -      | 340    | 440   | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=-75\text{ V}$ , $f=1\text{ MHz}$   |
| Reverse transfer capacitance <sup>1)</sup> | $C_{rss}$    | -      | 63     | 110   | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=-75\text{ V}$ , $f=1\text{ MHz}$   |
| Turn-on delay time                         | $t_{d(on)}$  | -      | 23.93  | -     | ns   | $V_{DD}=-75\text{ V}$ , $V_{GS}=-4.5\text{ V}$ , $I_D=-37\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Rise time                                  | $t_r$        | -      | 91.68  | -     | ns   | $V_{DD}=-75\text{ V}$ , $V_{GS}=-4.5\text{ V}$ , $I_D=-37\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Turn-off delay time                        | $t_{d(off)}$ | -      | 204.9  | -     | ns   | $V_{DD}=-75\text{ V}$ , $V_{GS}=-4.5\text{ V}$ , $I_D=-37\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Fall time                                  | $t_f$        | -      | 128.05 | -     | ns   | $V_{DD}=-75\text{ V}$ , $V_{GS}=-4.5\text{ V}$ , $I_D=-37\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |

**Table 6 Gate charge characteristics<sup>2)</sup>**

| Parameter                          | Symbol        | Values |       |      | Unit | Note / Test Condition   |
|------------------------------------|---------------|--------|-------|------|------|---|
|                                    |               | Min.   | Typ.  | Max. |      |   |
| Gate to source charge              | $Q_{gs}$      | -      | -24   | -    | nC   | $V_{DD}=-75\text{ V}$ , $I_D=-37\text{ A}$ , $V_{GS}=0\text{ to }-4.5\text{ V}$ |
| Gate charge at threshold           | $Q_{g(th)}$   | -      | -12.6 | -    | nC   | $V_{DD}=-75\text{ V}$ , $I_D=-37\text{ A}$ , $V_{GS}=0\text{ to }-4.5\text{ V}$ |
| Gate to drain charge <sup>1)</sup> | $Q_{gd}$      | -      | -52   | -78  | nC   | $V_{DD}=-75\text{ V}$ , $I_D=-37\text{ A}$ , $V_{GS}=0\text{ to }-4.5\text{ V}$ |
| Switching charge                   | $Q_{sw}$      | -      | -64   | -    | nC   | $V_{DD}=-75\text{ V}$ , $I_D=-37\text{ A}$ , $V_{GS}=0\text{ to }-4.5\text{ V}$ |
| Gate charge total <sup>1)</sup>    | $Q_g$         | -      | -110  | -138 | nC   | $V_{DD}=-75\text{ V}$ , $I_D=-37\text{ A}$ , $V_{GS}=0\text{ to }-4.5\text{ V}$ |
| Gate plateau voltage               | $V_{plateau}$ | -      | -2.9  | -    | V    | $V_{DD}=-75\text{ V}$ , $I_D=-37\text{ A}$ , $V_{GS}=0\text{ to }-4.5\text{ V}$ |
| Gate charge total                  | $Q_g$         | -      | -224  | -    | nC   | $V_{DD}=-75\text{ V}$ , $I_D=-37\text{ A}$ , $V_{GS}=0\text{ to }-10\text{ V}$  |
| Output charge <sup>1)</sup>        | $Q_{oss}$     | -      | -61   | -81  | nC   | $V_{DS}=-75\text{ V}$ , $V_{GS}=0\text{ V}$                                     |

<sup>1)</sup> Defined by design. Not subject to production test.

<sup>2)</sup> See "Gate charge waveforms" for parameter definition

**Table 7 Reverse diode**

| Parameter                             | Symbol        | Values |        |        | Unit | Note / Test Condition   |
|---------------------------------------|---------------|--------|--------|--------|------|---|
|                                       |               | Min.   | Typ.   | Max.   |      |   |
| Diode continuous forward current      | $I_S$         | -      | -      | -41    | A    | $T_C=25\text{ °C}$  |
| Diode pulse current                   | $I_{S,pulse}$ | -      | -      | -164   | A    | $T_C=25\text{ °C}$  |
| Diode forward voltage                 | $V_{SD}$      | -      | -0.84  | -1.2   | V    | $V_{GS}=0\text{ V}, I_F=-37\text{ A}, T_j=25\text{ °C}$                 |
| Reverse recovery time <sup>1)</sup>   | $t_{rr}$      | -      | 118.8  | 237.6  | ns   | $V_R=-75\text{ V}, I_F=-37\text{ A}, di_F/dt=-100\text{ A}/\mu\text{s}$ |
| Reverse recovery charge <sup>1)</sup> | $Q_{rr}$      | -      | 671.02 | 1342.0 | nC   | $V_R=-75\text{ V}, I_F=-37\text{ A}, di_F/dt=-100\text{ A}/\mu\text{s}$ |

<sup>1)</sup> Defined by design. Not subject to production test.

### 4 Electrical characteristics diagrams

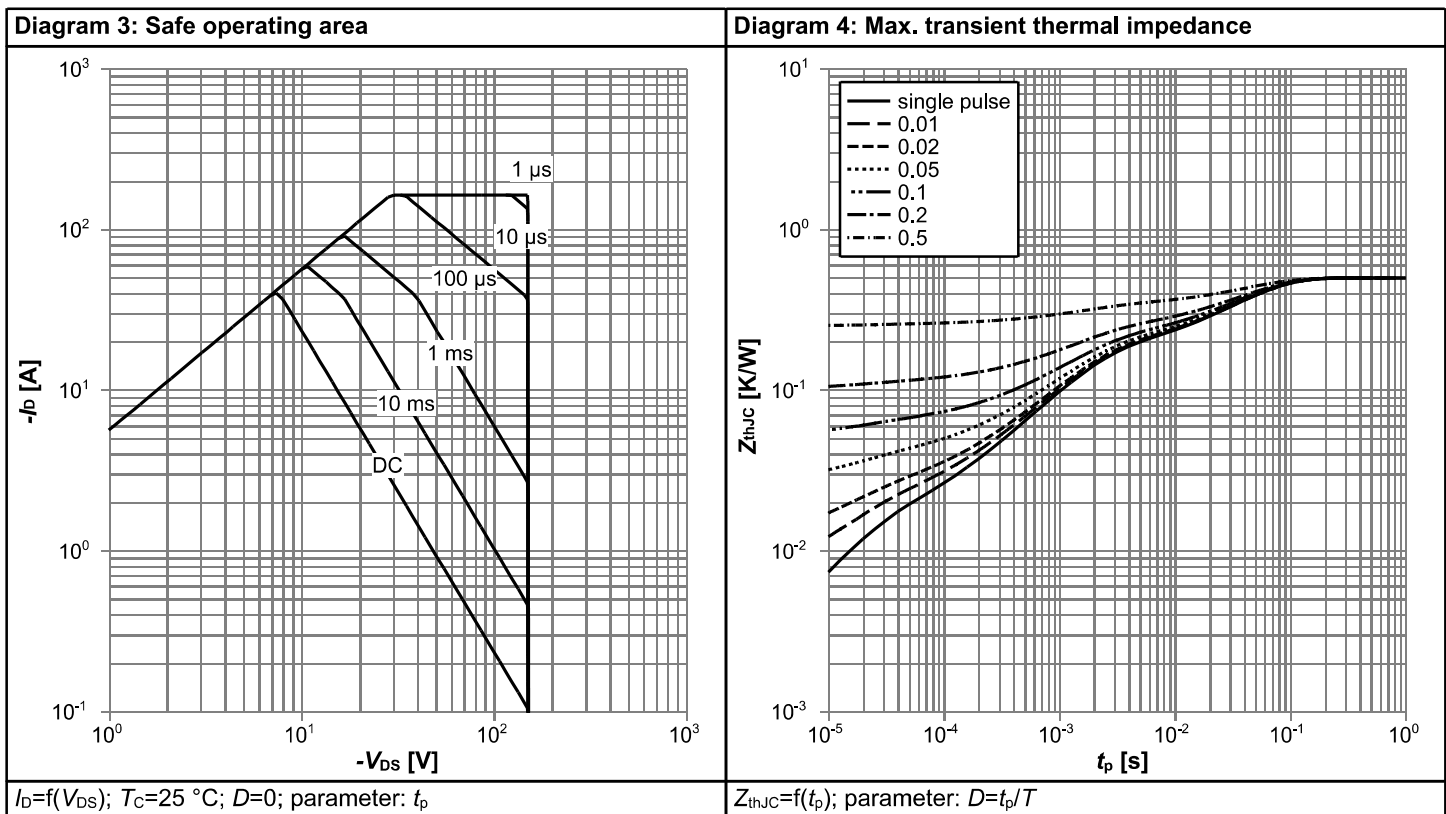
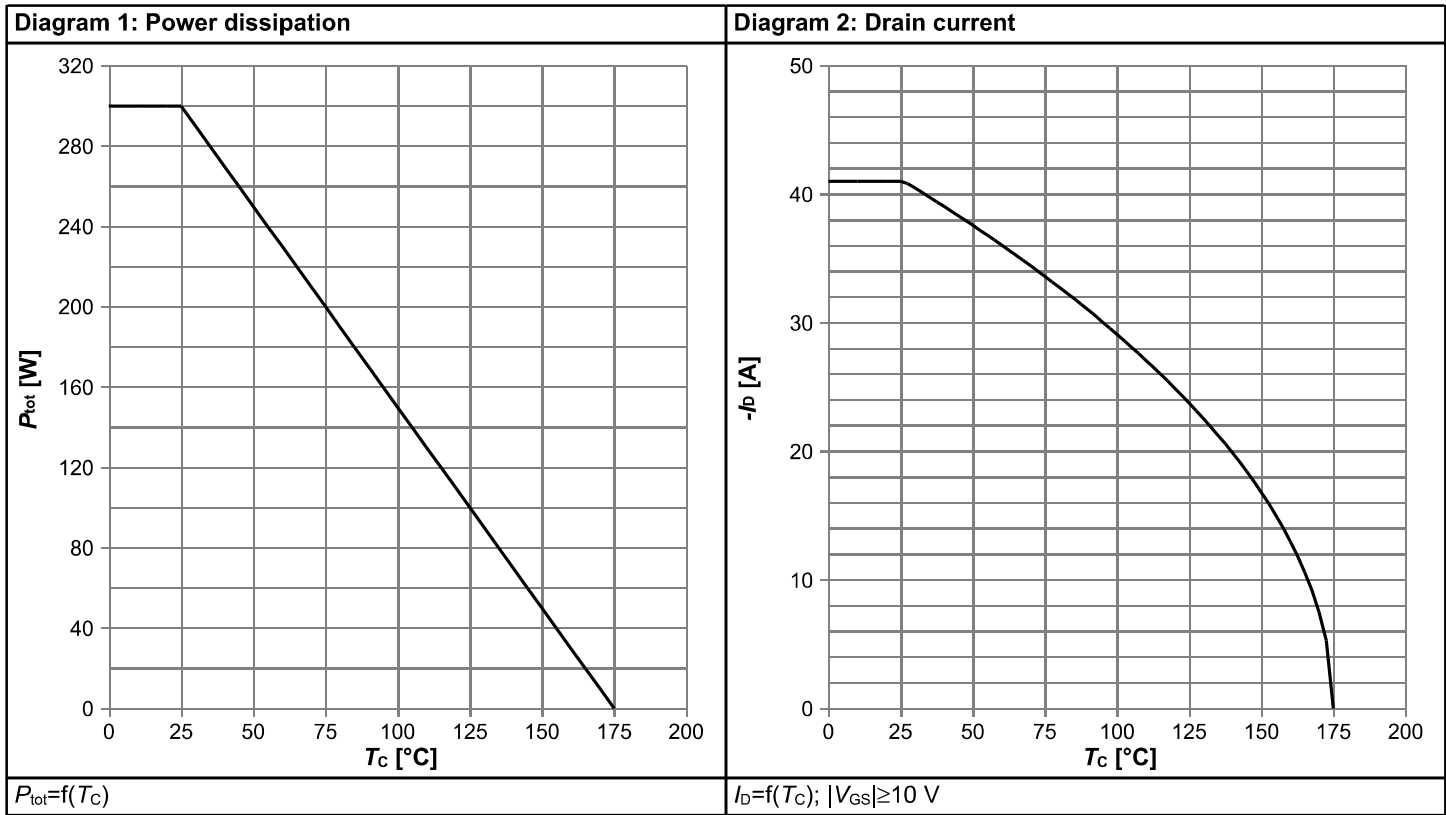
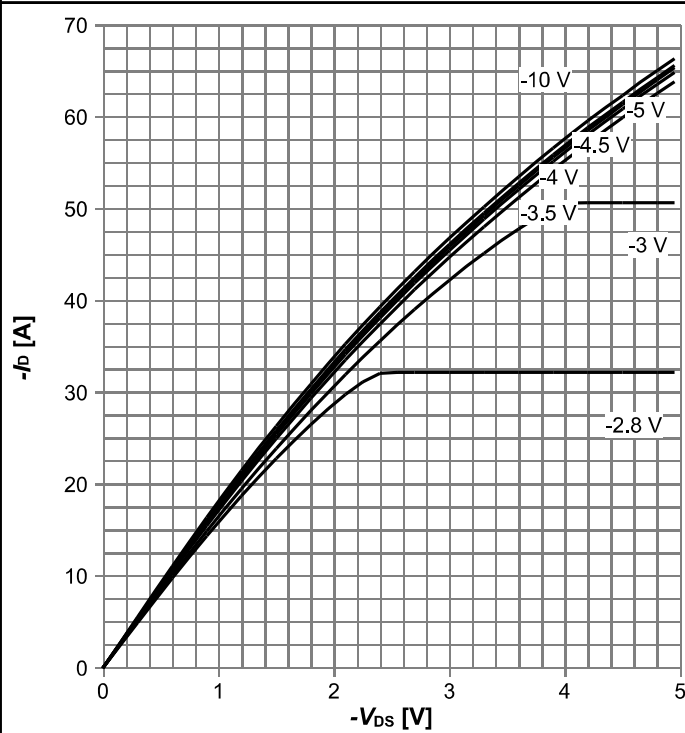
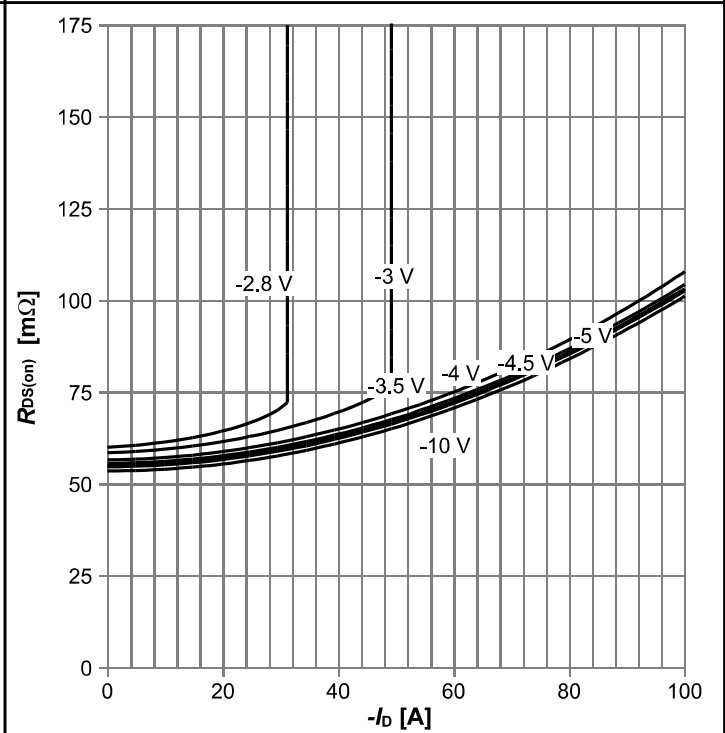


Diagram 5: Typ. output characteristics



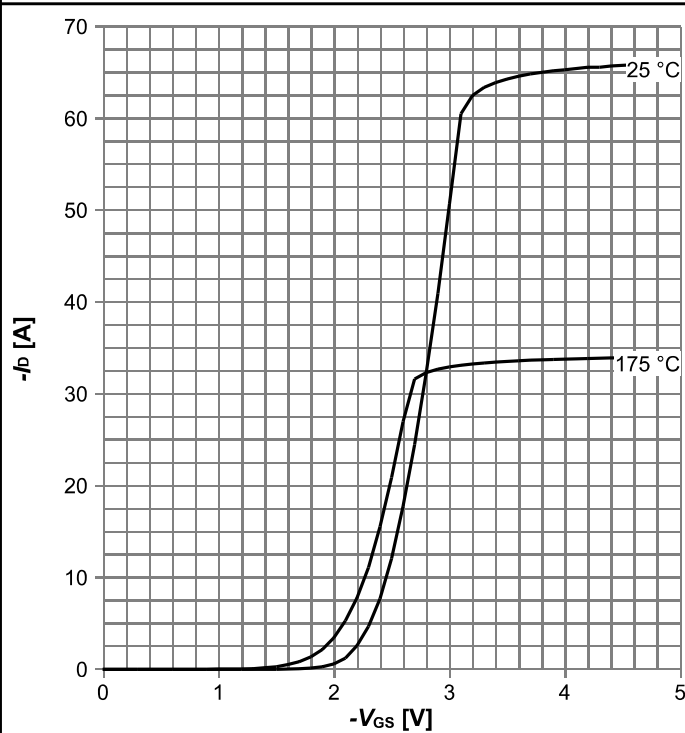
$I_D = f(V_{DS})$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 6: Typ. drain-source on resistance



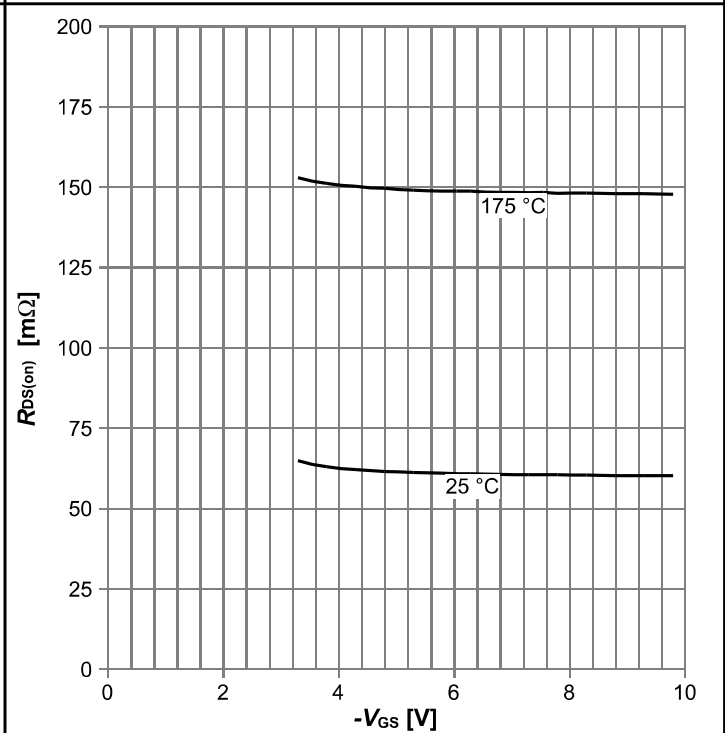
$R_{DS(on)} = f(I_D)$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 7: Typ. transfer characteristics



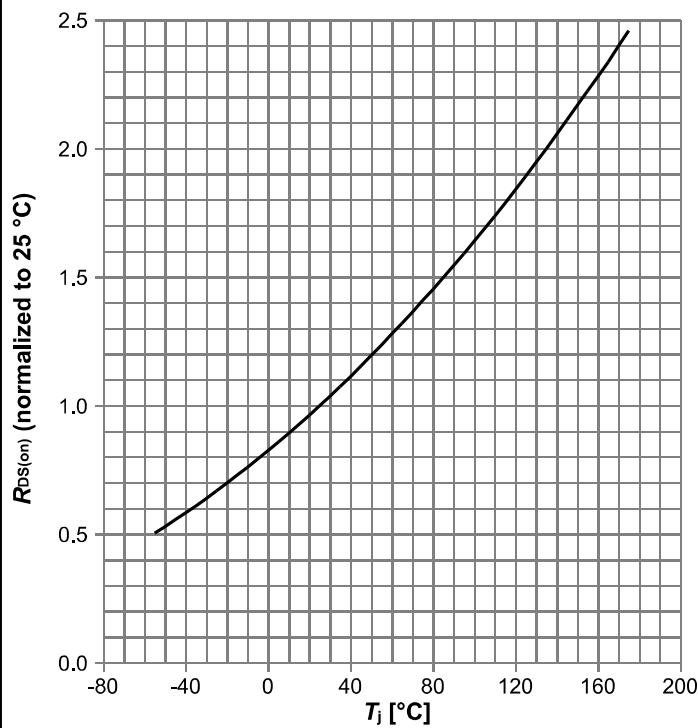
$I_D = f(V_{GS})$ ,  $|V_{DS}| > 2|I_D|R_{DS(on)max}$ ; parameter:  $T_j$

Diagram 8: Typ. drain-source on resistance



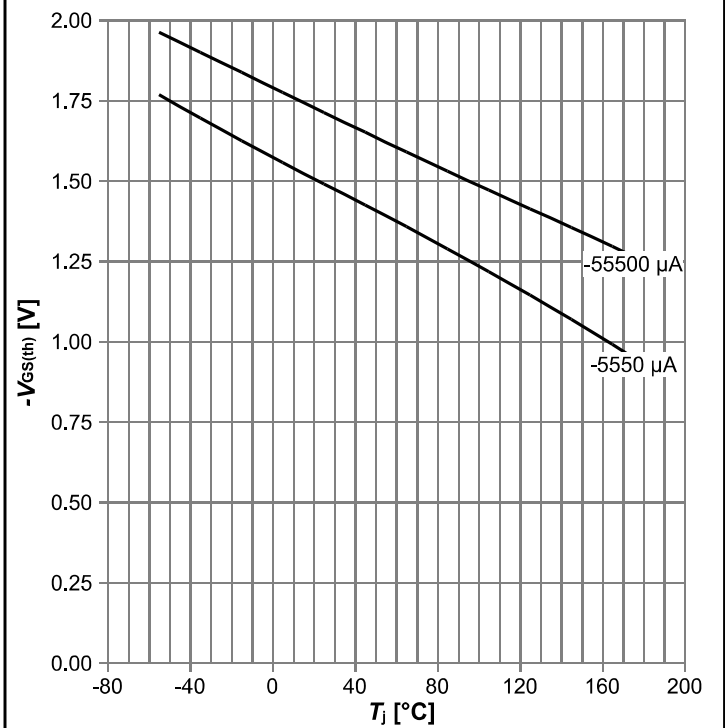
$R_{DS(on)} = f(V_{GS})$ ,  $I_D = -37\text{ A}$ ; parameter:  $T_j$

Diagram 9: Normalized drain-source on resistance



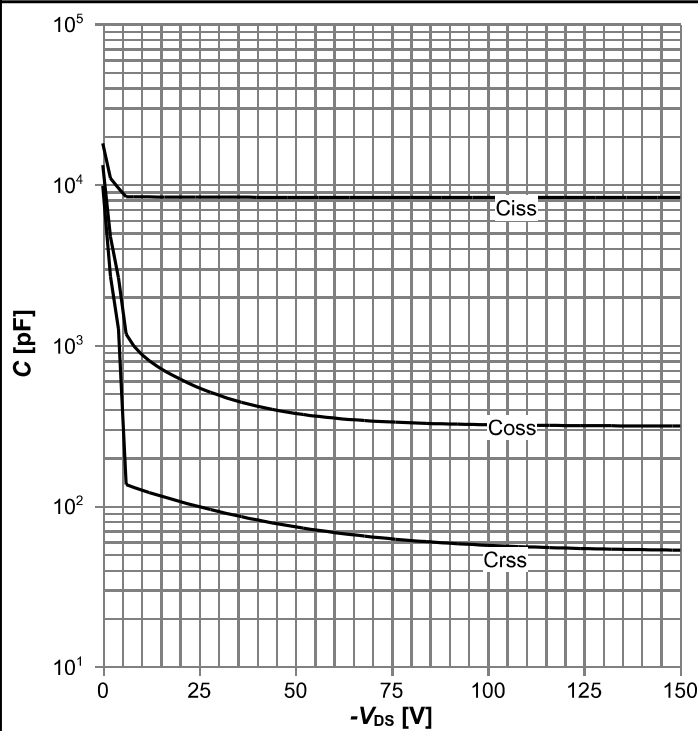
$R_{DS(on)}=f(T_j)$ ,  $I_D=-37$  A,  $V_{GS}=-10$  V

Diagram 10: Typ. gate threshold voltage



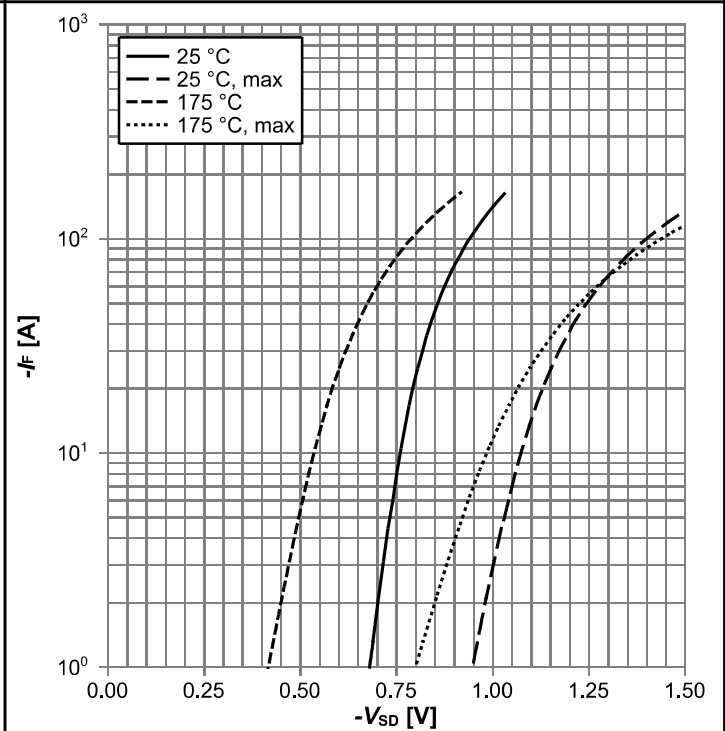
$V_{GS(th)}=f(T_j)$ ,  $V_{GS}=V_{DS}$ ; parameter:  $I_D$

Diagram 11: Typ. capacitances



$C=f(V_{DS})$ ;  $V_{GS}=0$  V;  $f=1$  MHz

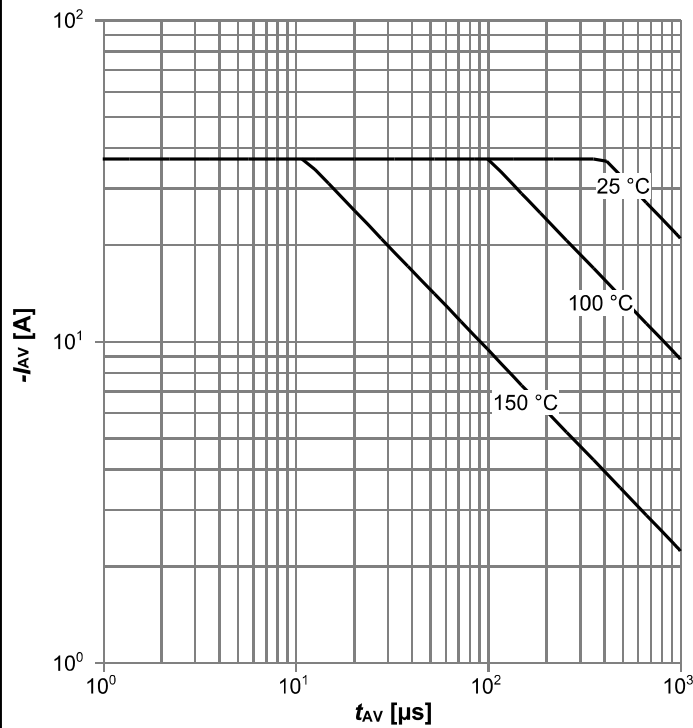
Diagram 12: Forward characteristics of reverse diode



$I_F=f(V_{SD})$ ; parameter:  $T_j$

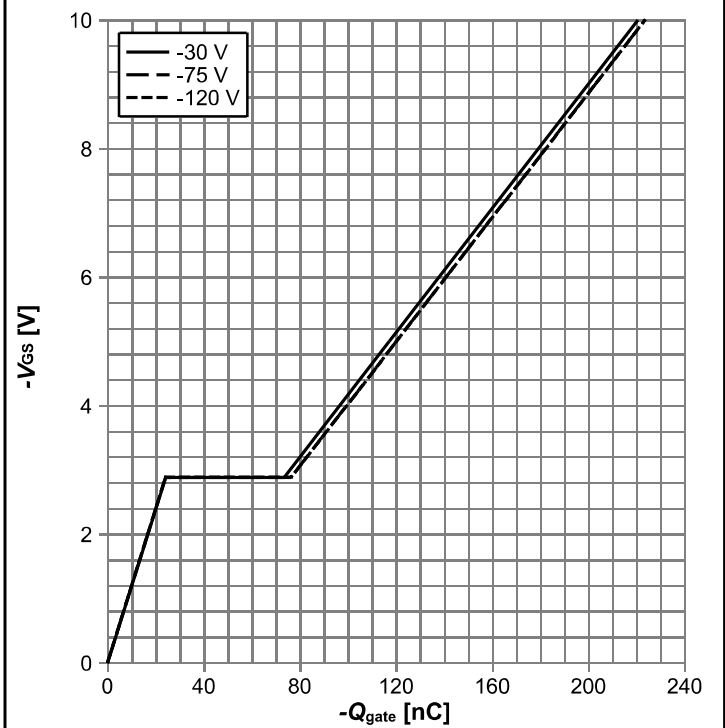


Diagram 13: Avalanche characteristics



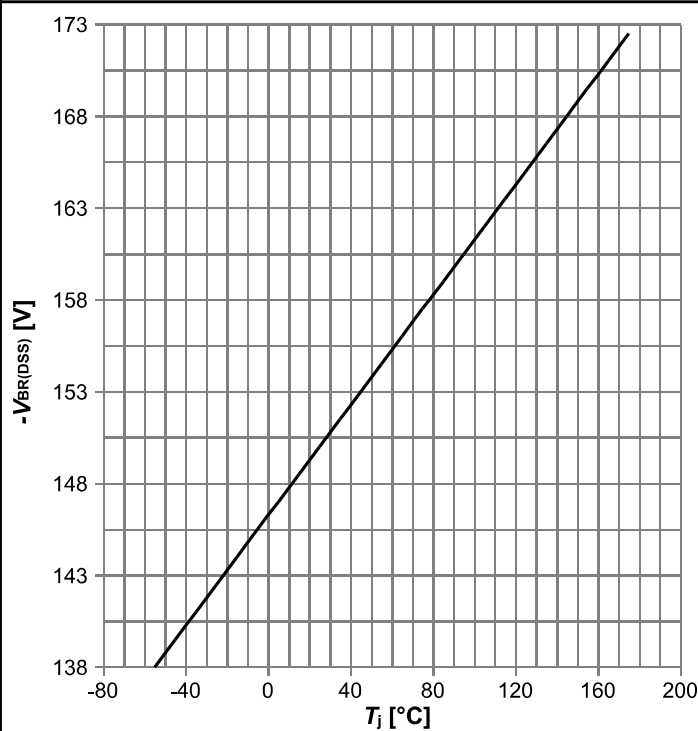
$I_{AS}=f(t_{AV}); R_{GS}=25 \Omega$ ; parameter:  $T_{j,start}$

Diagram 14: Typ. gate charge



$V_{GS}=f(Q_{gate}), I_D=-37$  A pulsed,  $T_j=25$  °C; parameter:  $V_{DD}$

Diagram 15: Drain-source breakdown voltage



$V_{BR(DSS)}=f(T_j); I_D=-1$  mA

Diagram Gate charge waveforms



## 5 Package Outlines

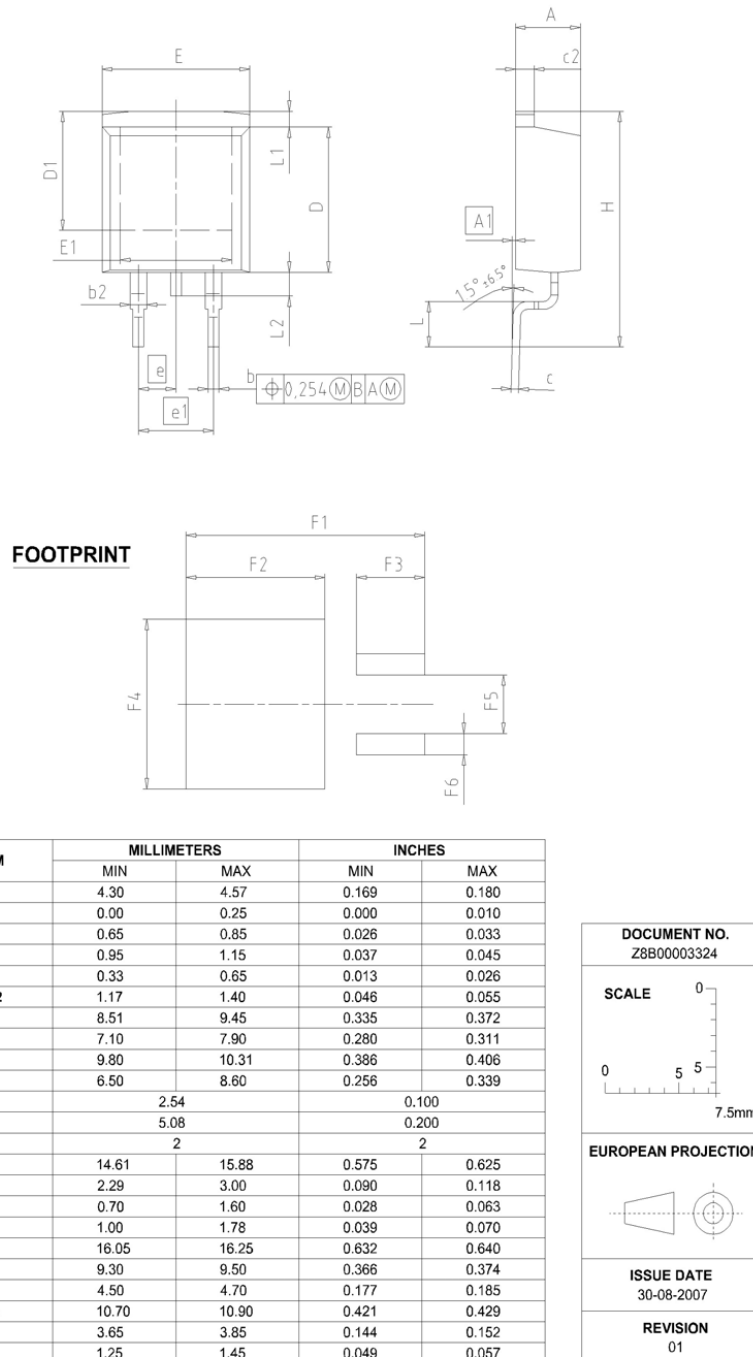


Figure 1 Outline PG-TO263-3, dimensions in mm/inches

## Revision History

IPB720P15LM

**Revision: 2021-05-10, Rev. 2.0**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.0      | 2021-05-10 | Release of final version                     |

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